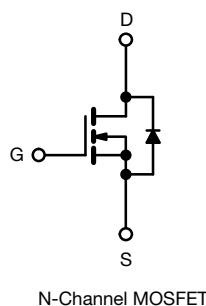


## E Series Power MOSFET



### FEATURES

- Low figure-of-merit (FOM)  $R_{on} \times Q_g$
- Low input capacitance ( $C_{iss}$ )
- Reduced switching and conduction losses
- Ultra low gate charge ( $Q_g$ )
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### PRODUCT SUMMARY

$V_{DS}$ (V) at $T_J$ max.	650	
$R_{DS(on)}$ typ. ( $\Omega$ ) at 25 °C	$V_{GS} = 10$ V	0.313
$Q_g$ max. (nC)	50	
$Q_{gs}$ (nC)	6	
$Q_{gd}$ (nC)	13	
Configuration	Single	

### APPLICATIONS

- Switch mode power supplies (SMPS)
- Flyback converter
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Consumer
  - Wall adaptors

### ORDERING INFORMATION

Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SiHJ10N60E-T1-GE3

### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	$V_{DS}$	600	V
Gate-source voltage	$V_{GS}$	$\pm 30$	
Continuous drain current ( $T_J = 150$ °C)	$V_{GS}$ at 10 V	10	A
		6	
Pulsed drain current <sup>a</sup>	$I_{DM}$	23	
Linear derating factor		0.71	W/°C
Single pulse avalanche energy <sup>b</sup>	$E_{AS}$	95	mJ
Maximum power dissipation	$P_D$	89	W
Operating junction and storage temperature range	$T_J, T_{stg}$	-55 to +150	°C
Drain-source voltage slope	$T_J = 125$ °C	70	V/ns
		26	

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- $V_{DD} = 120$  V, starting  $T_J = 25$  °C,  $L = 28.2$  mH,  $R_g = 25$  Ω,  $I_{AS} = 2.6$  A.
- $I_{SD} \leq I_D$ ,  $dI/dt = 100$  A/μs, starting  $T_J = 25$  °C.

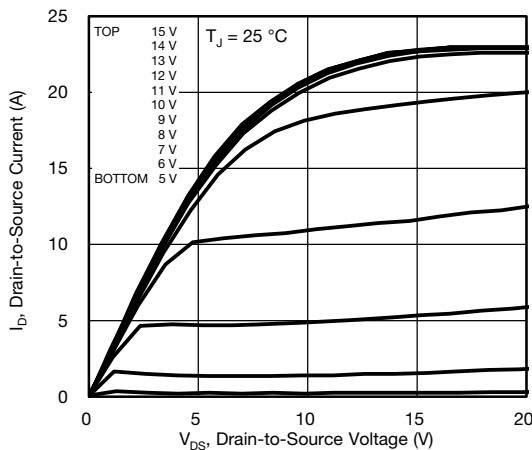
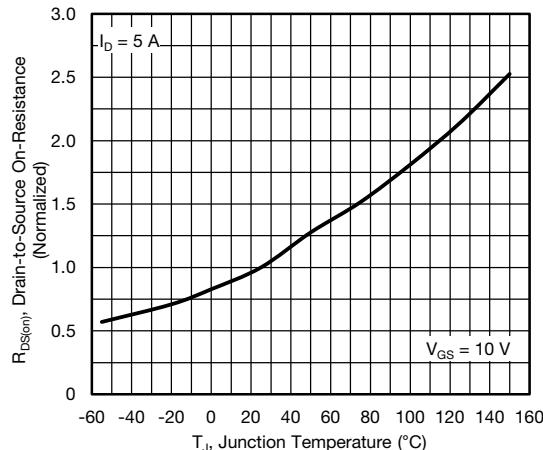
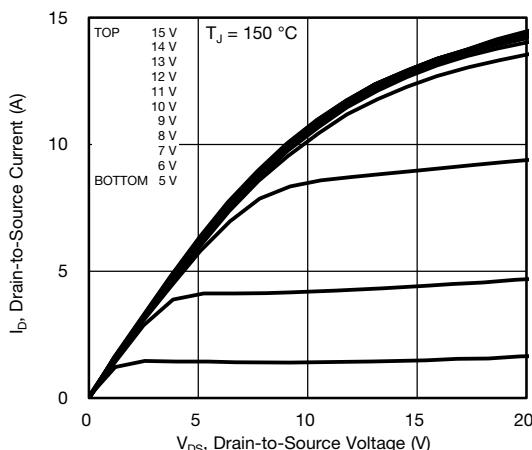
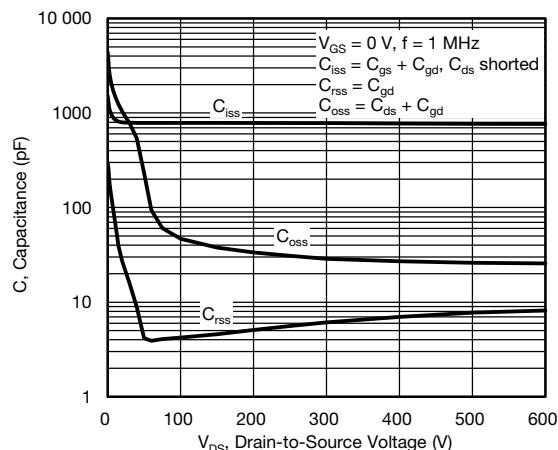
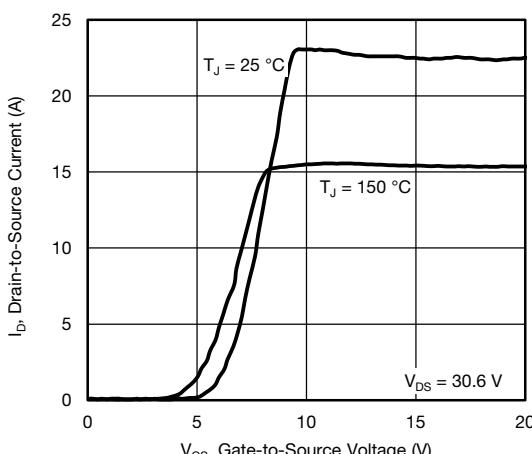
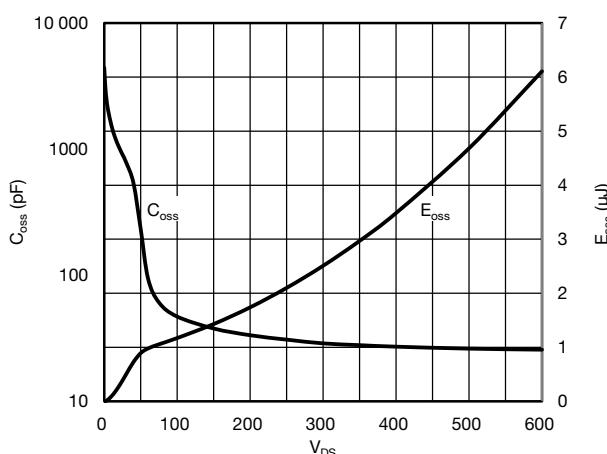
### THERMAL RESISTANCE RATINGS

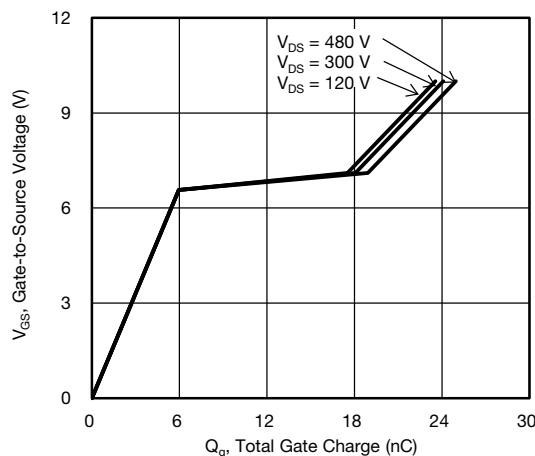
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	$R_{thJA}$	52	65	°C/W
Maximum junction-to-case (drain)	$R_{thJC}$	1.0	1.4	

<b>SPECIFICATIONS</b> ( $T_J = 25^\circ\text{C}$ , unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
<b>Static</b>								
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$		600	-	-	V	
$V_{DS}$ temperature coefficient	$\Delta V_{DS}/T_J$	Reference to $25^\circ\text{C}$ , $I_D = 1 \text{ mA}$		-	0.7	-	$\text{V}^\circ\text{C}$	
Gate-source threshold voltage (N)	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$		2.5	-	4.5	V	
Gate-source leakage	$I_{GSS}$	$V_{GS} = \pm 20 \text{ V}$		-	-	$\pm 100$	nA	
		$V_{GS} = \pm 30 \text{ V}$		-	-	$\pm 1$	$\mu\text{A}$	
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 600 \text{ V}$ , $V_{GS} = 0 \text{ V}$		-	-	1	$\mu\text{A}$	
		$V_{DS} = 480 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_J = 125^\circ\text{C}$		-	-	10		
Drain-source on-state resistance	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}$	$I_D = 5 \text{ A}$	-	0.313	0.360	$\Omega$	
Forward transconductance	$g_{fs}$	$V_{DS} = 30 \text{ V}$ , $I_D = 5 \text{ A}$		-	2.5	-	S	
<b>Dynamic</b>								
Input capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V}$ , $V_{DS} = 100 \text{ V}$ , $f = 1 \text{ MHz}$		-	784	-	pF	
Output capacitance	$C_{oss}$			-	47	-		
Reverse transfer capacitance	$C_{rss}$			-	4	-		
Effective output capacitance, energy related a	$C_{o(er)}$	$V_{DS} = 0 \text{ V to } 480 \text{ V}$ , $V_{GS} = 0 \text{ V}$		-	30	-		
Effective output capacitance, time related b	$C_{o(tr)}$			-	145	-		
Total gate charge	$Q_g$		$V_{GS} = 10 \text{ V}$	$I_D = 5 \text{ A}$ , $V_{DS} = 480 \text{ V}$	-	25	50	nC
Gate-source charge	$Q_{gs}$				-	6	-	
Gate-drain charge	$Q_{gd}$				-	13	-	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 480 \text{ V}$ , $I_D = 5 \text{ A}$ , $V_{GS} = 10 \text{ V}$ , $R_g = 9.1 \Omega$			-	16	32	ns
Rise time	$t_r$				-	24	48	
Turn-off delay time	$t_{d(off)}$				-	31	62	
Fall time	$t_f$				-	13	26	
Gate input resistance	$R_g$	$f = 1 \text{ MHz}$		0.4	0.8	1.6	$\Omega$	
<b>Drain-Source Body Diode Characteristics</b>								
Continuous source-drain diode current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode			-	-	10	A
Pulsed diode forward current	$I_{SM}$				-	-	23	
Diode forward voltage	$V_{SD}$	$T_J = 25^\circ\text{C}$ , $I_S = 5 \text{ A}$ , $V_{GS} = 0 \text{ V}$		-	0.9	1.2	V	
Reverse recovery time	$t_{rr}$	$T_J = 25^\circ\text{C}$ , $I_F = I_S = 5 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$ , $V_R = 25 \text{ V}$			-	241	482	ns
Reverse recovery charge	$Q_{rr}$				-	2.6	5.2	$\mu\text{C}$
Reverse recovery current	$I_{RRM}$				-	20	-	A

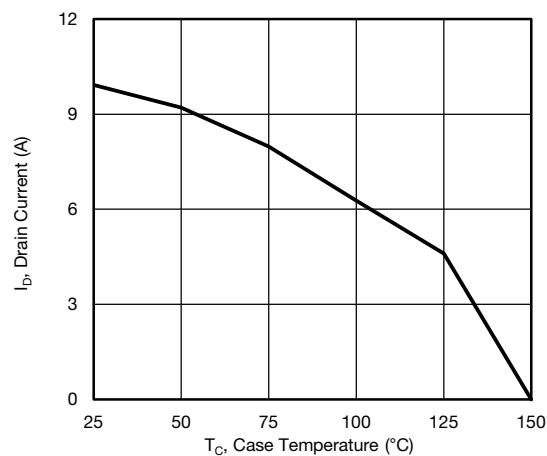
**Notes**

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .  
b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

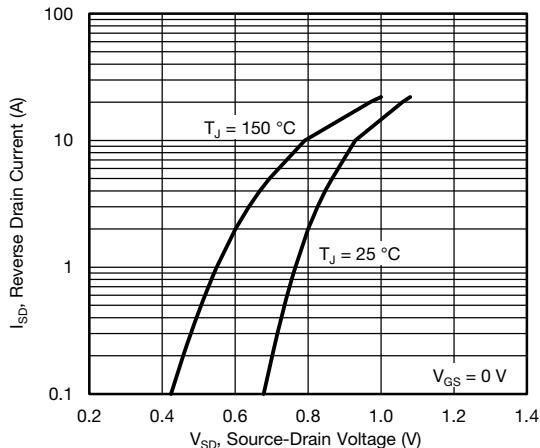
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Fig. 1 - Typical Output Characteristics**

**Fig. 4 - Normalized On-Resistance vs. Temperature**

**Fig. 2 - Typical Output Characteristics**

**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

**Fig. 3 - Typical Transfer Characteristics**

**Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$**



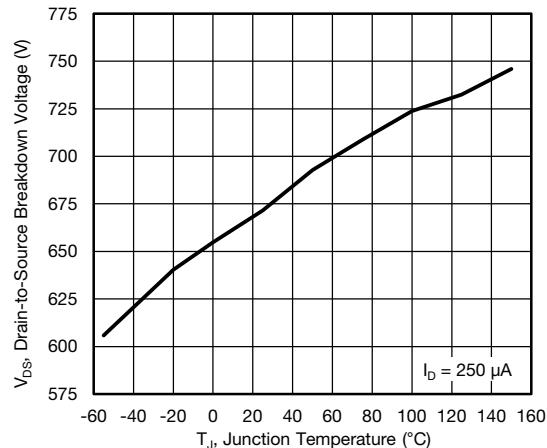
**Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage**



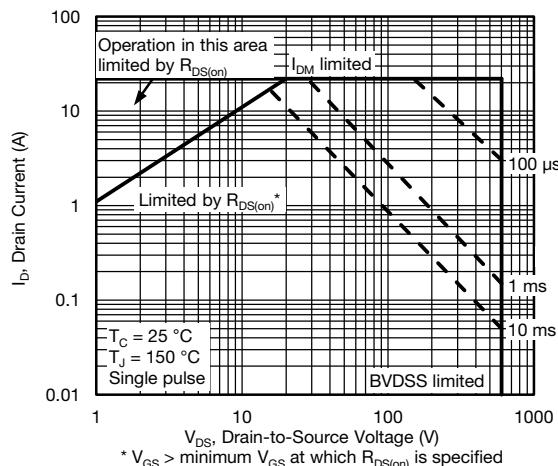
**Fig. 10 - Maximum Drain Current vs. Case Temperature**



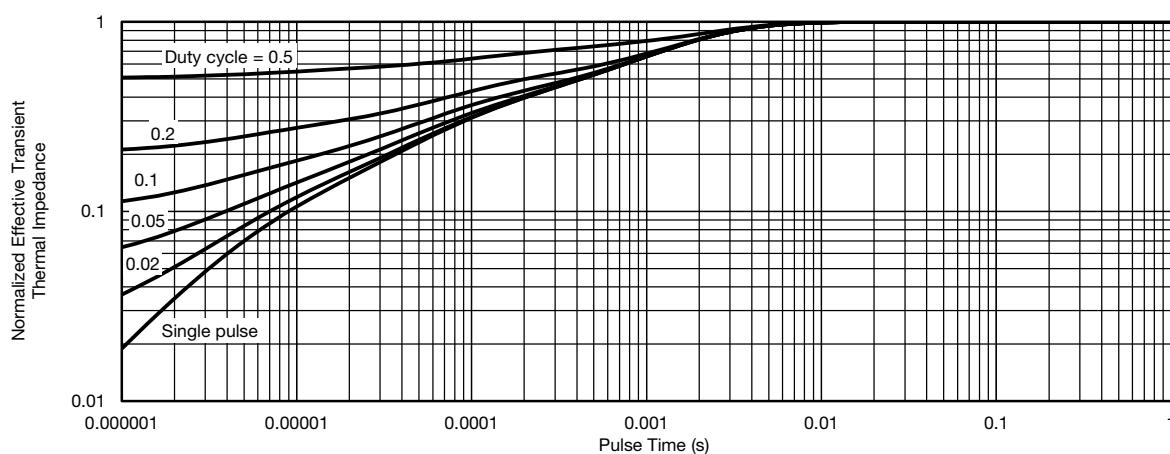
**Fig. 8 - Typical Source-Drain Diode Forward Voltage**



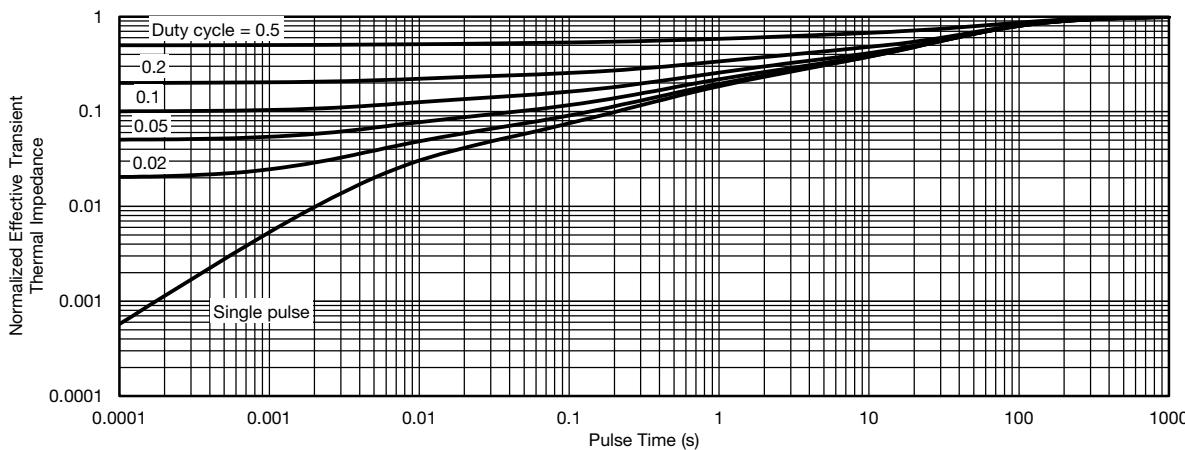
**Fig. 11 - Temperature vs. Drain-to-Source Voltage**



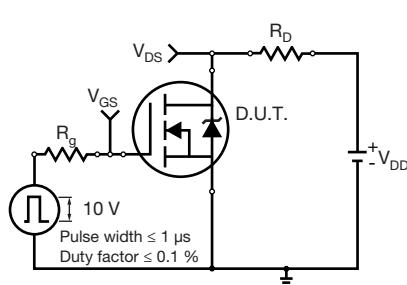
**Fig. 9 - Maximum Safe Operating Area**



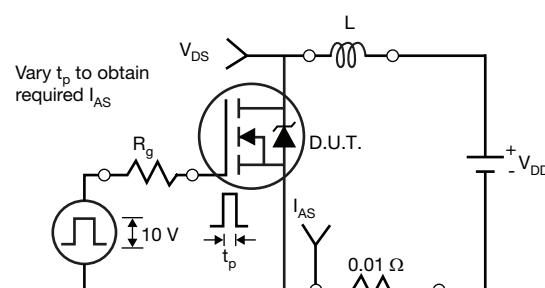
**Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case**



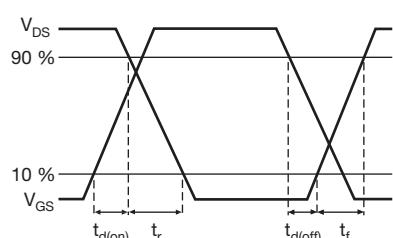
**Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient**



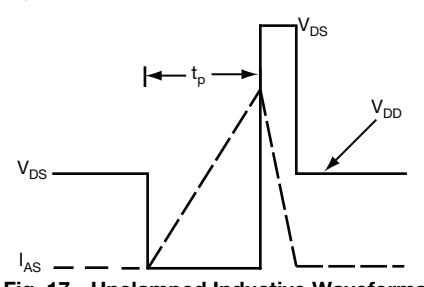
**Fig. 14 - Switching Time Test Circuit**



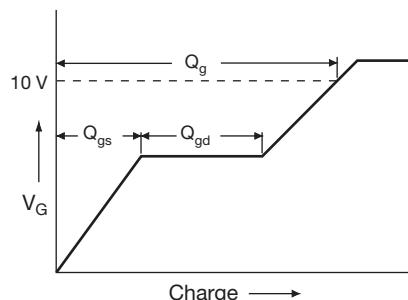
**Fig. 16 - Unclamped Inductive Test Circuit**



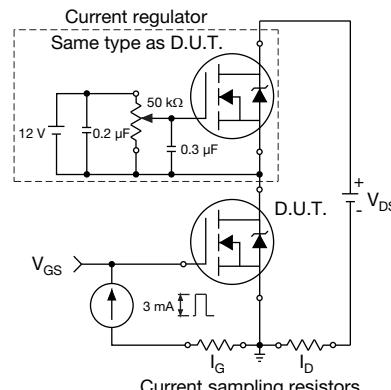
**Fig. 15 - Switching Time Waveforms**



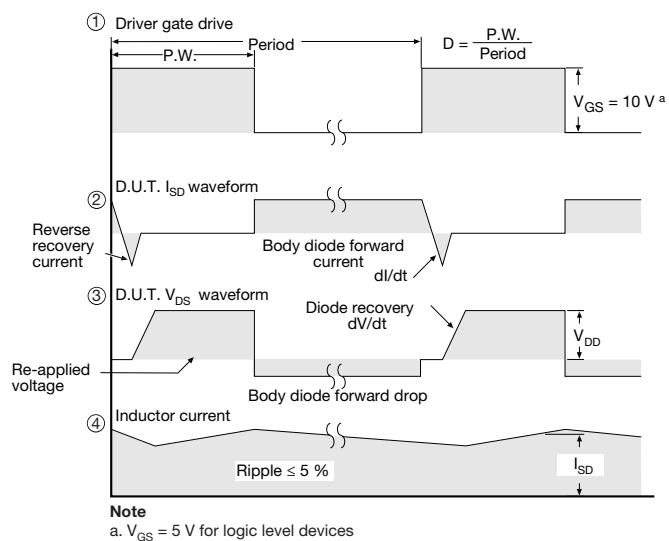
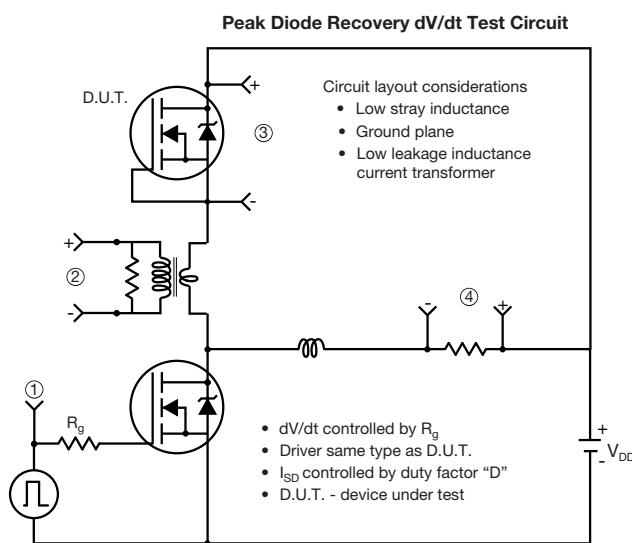
**Fig. 17 - Unclamped Inductive Waveforms**



**Fig. 18 - Basic Gate Charge Waveform**



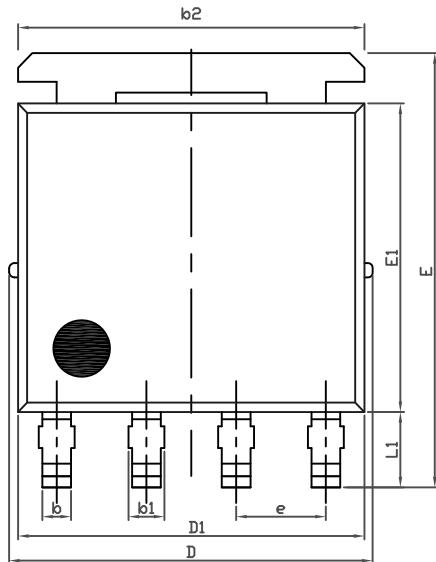
**Fig. 19 - Gate Charge Test Circuit**



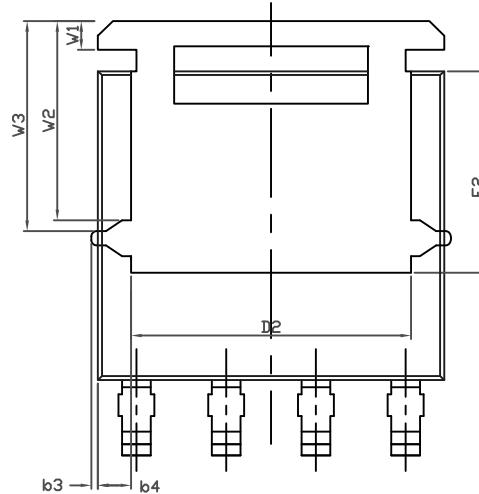
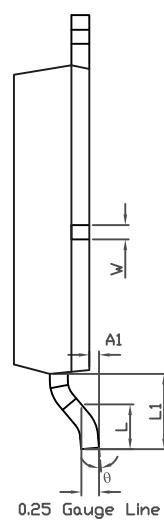
**Fig. 20 - For N-Channel**

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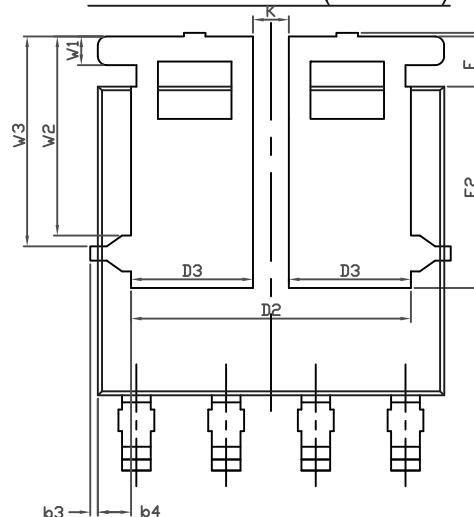
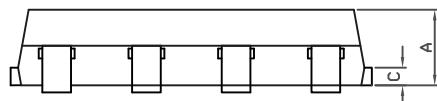
## PowerPAK® SO-8L Case Outline for AI Parts



TOPSIDE VIEW



BACKSIDE VIEW(SINGLE)



BACKSIDE VIEW(DUAL)



DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	1.00	1.07	1.14	0.039	0.042	0.045
A1	0.00	-	0.127	0.00	-	0.005
b	0.33	0.41	0.48	0.013	0.016	0.019
b1	0.44	0.51	0.58	0.017	0.020	0.023
b2	4.80	4.90	5.00	0.189	0.193	0.197
b3	0.094			0.004		
b4	0.47			0.019		
c	0.20	0.25	0.30	0.008	0.010	0.012
D	5.00	5.13	5.25	0.197	0.202	0.207
D1	4.80	4.90	5.00	0.189	0.193	0.197
D2	3.86	3.96	4.06	0.152	0.156	0.160
D3	1.63	1.73	1.83	0.064	0.068	0.072
e	1.27 BSC			0.050 BSC		
E	6.05	6.15	6.25	0.238	0.242	0.246
E1	4.27	4.37	4.47	0.168	0.172	0.176
E2	2.75	2.85	2.95	0.108	0.112	0.116
F	-	-	0.15	-	-	0.006
L	0.62	0.72	0.82	0.024	0.028	0.032
L1	0.92	1.07	1.22	0.036	0.042	0.048
K	0.51			0.020		
W	0.23			0.009		
W1	0.41			0.016		
W2	2.82			0.111		
W3	2.96			0.117		
q	0°	-	10°	0°	-	10°

ECN: C15-1203-Rev. A, 07-Sep-15

DWG: 6044

**Note**

- Millimeters will govern



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